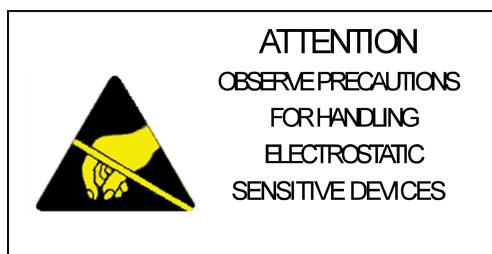


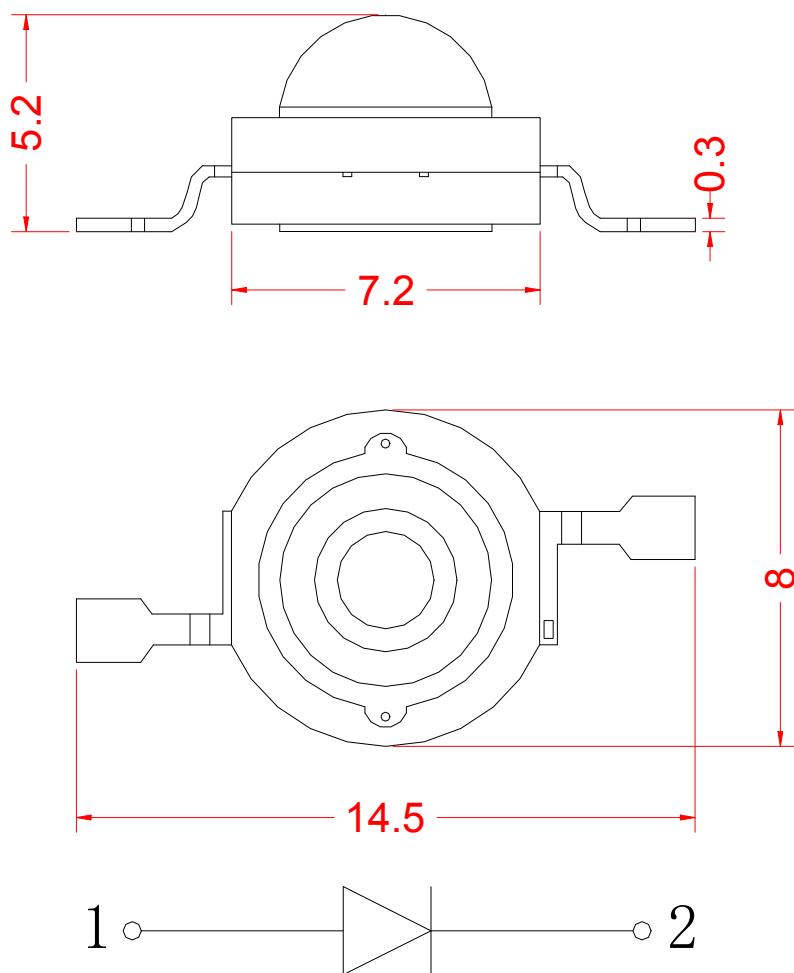
**WCN-03L2NW-110-CE-40****SPECIFICATION**

WCN			CUSTOMER Confirmed
Prepared by	Checked by	Approved by	
LiuGuo 2018-11-9	ZhangChun 2018-11-9		



**Description**

- ◆ Viewing angle:110 deg
- ◆ The materials of the LED dice is InGaN
- ◆ 14.5mm×8.0mm×5.2mm
- ◆ RoHS compliant lead-free soldering compatible

**Package Outline****NOTES:**

1. All dimensions units are millimeters ;
2. All dimensions tolerances are  $\pm 0.2\text{mm}$  unless otherwise noted.

**Absolute Maximum Ratings at Ta=25°C**

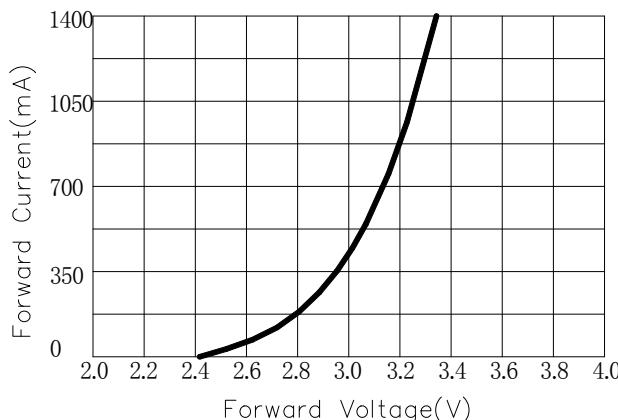
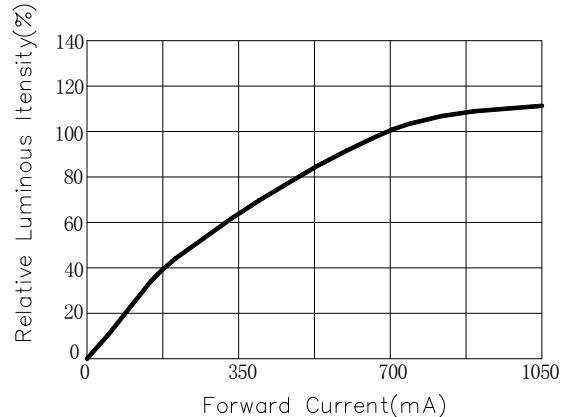
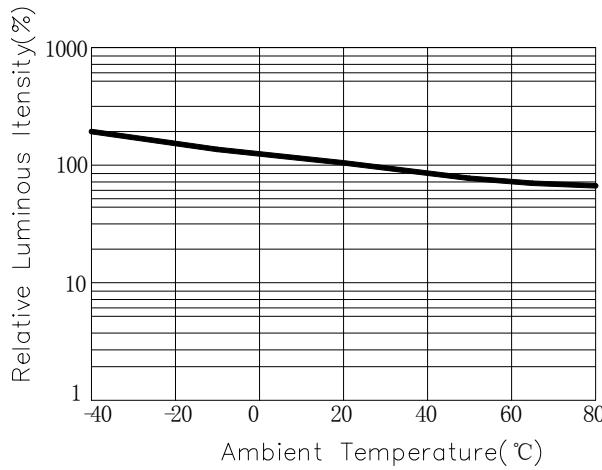
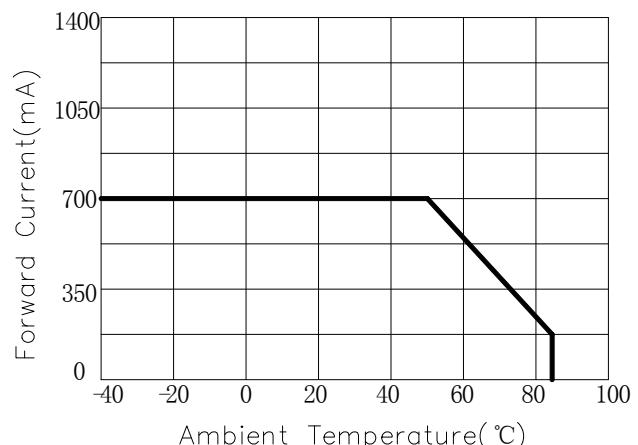
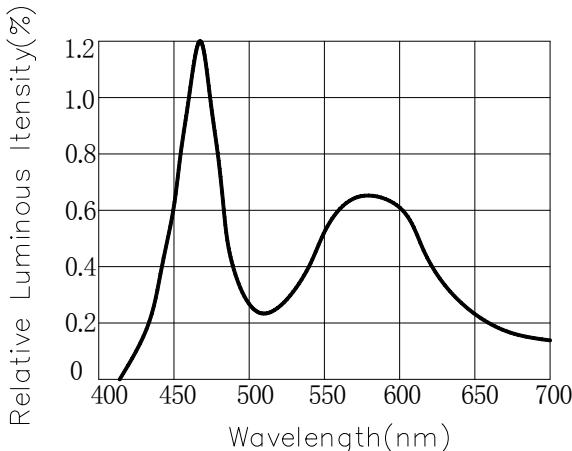
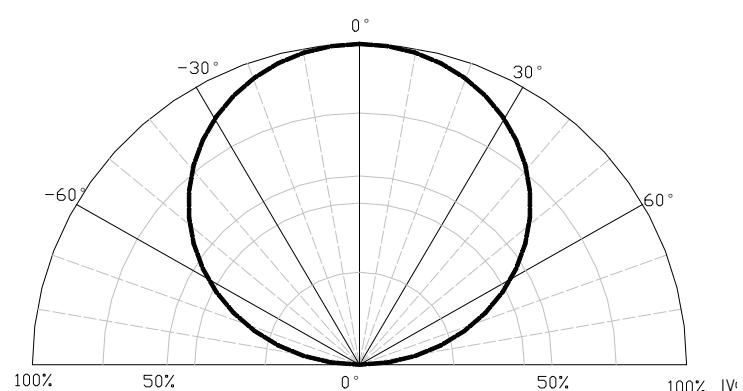
Parameter	Symbol	Rating	Units
Power Dissipation	Pd	2380	mW
Forward current	If	700	mA
Peak Forward Current	IFP	1000	mA
Reverse voltage	VR	5	V
Electrostatic Discharge	ESD	1000	V
Operating temperature	Topr	-30~+85	°C
Storage temperature	Tstg	-40 ~+100	°C

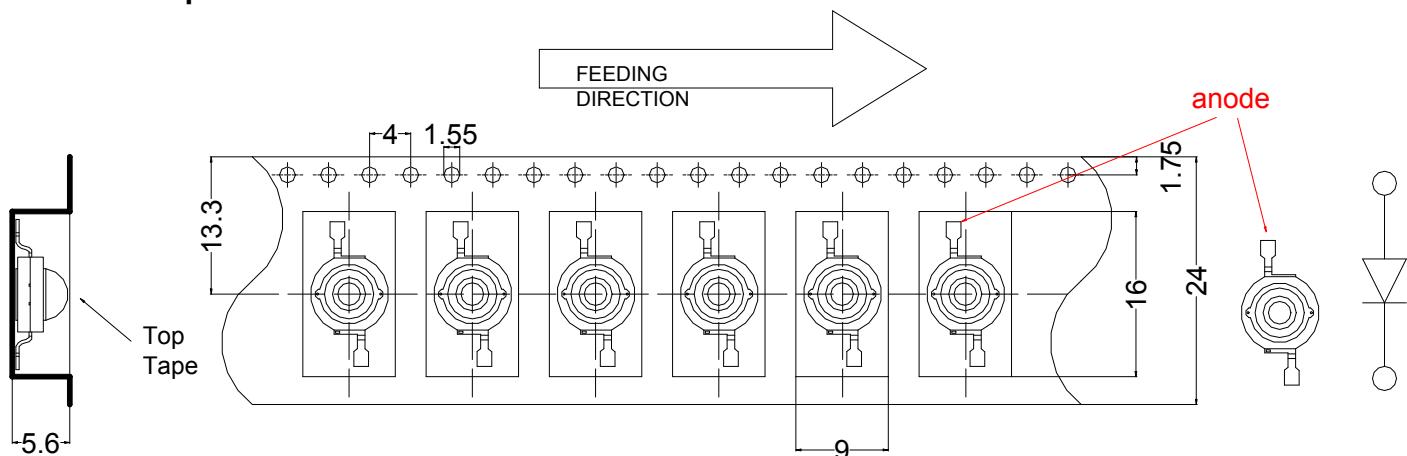
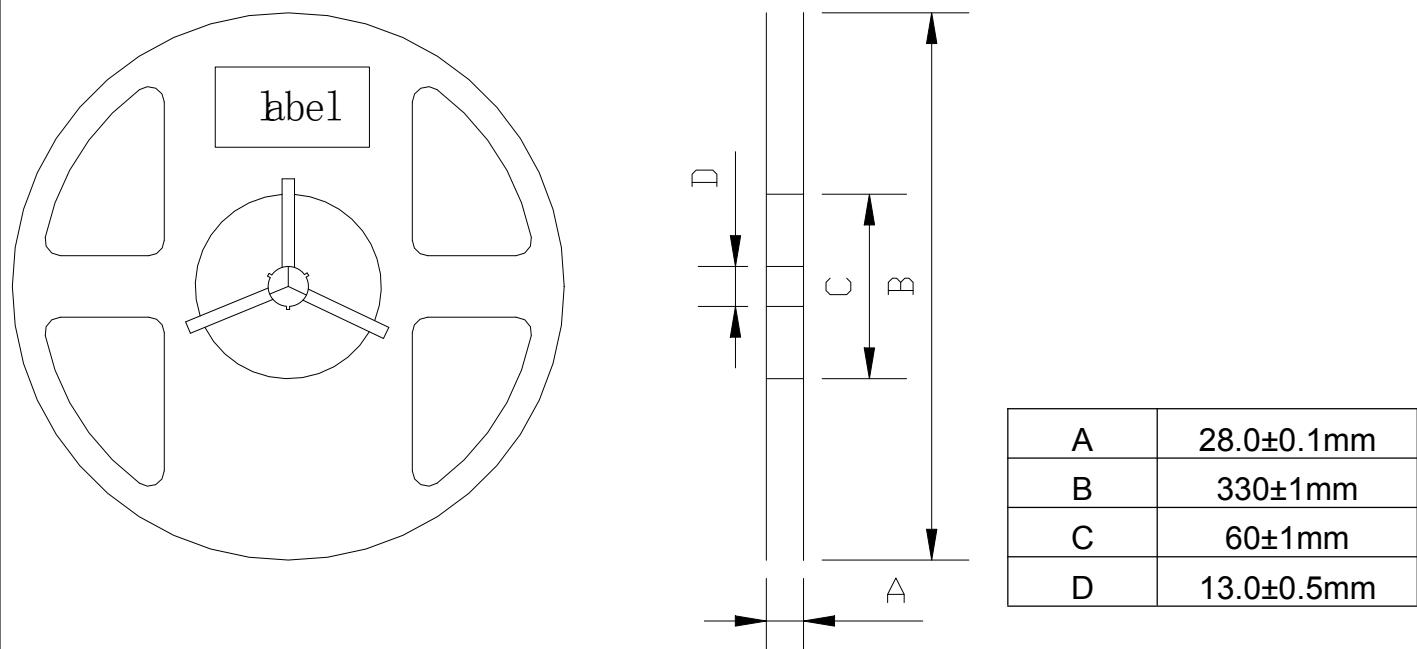
**Electrical/Optical characteristics at Ta=25°C**

Item	test condition	Symbol	Value			Unit
			Min.	Typ.	Max.	
Forward voltage	If=700mA	Vf	2.8	--	3.0	V
			3.0	--	3.2	V
			3.2	--	3.4	V
Luminous intensity	If=700mA	Iv	180	--	200	lm
			200	--	220	lm
			220	--	240	lm
Correlated Color Temperature	If=700mA	CCT	4000	--	4500	k
Viewing angle at 50% Iv	If=700mA	2θ1/2	--	110	--	Deg
Reverse current	Vr=5V	Ir	--	--	10	μA
Thermal resistance	If=700mA	Rth(j-s)	--	--	450	°C/W

**NOTE:**

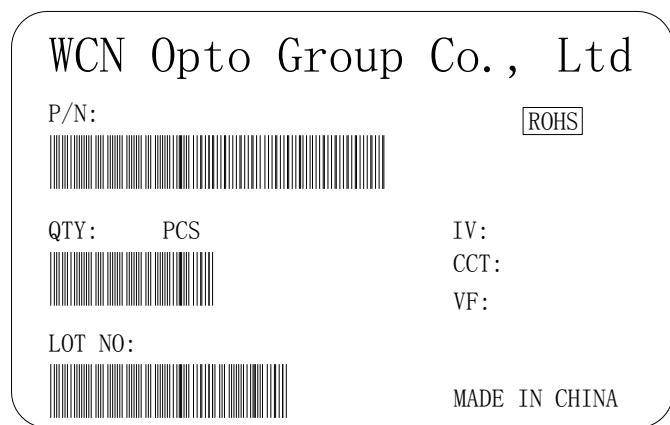
- 1.1/10 Duty cycle, 0.1ms pulse width.
2. The above forward voltage measurement allowance tolerance is 0.1V.
3. the above luminous intensity measurement allowance tolerance ±10%.

**Optical characteristics curves****Forward Current VS Forward Voltage****Relative Flux VS Forward Current****Relative Flux VS Ambient Temperature****Forward Current VS Ambient Temperature****Relative Spectral Distribution****Typical Spectral Distribution**

**Packaging Specifications****■ Carrier Tape Dimensions****■ Reel Dimension****NOTE:**

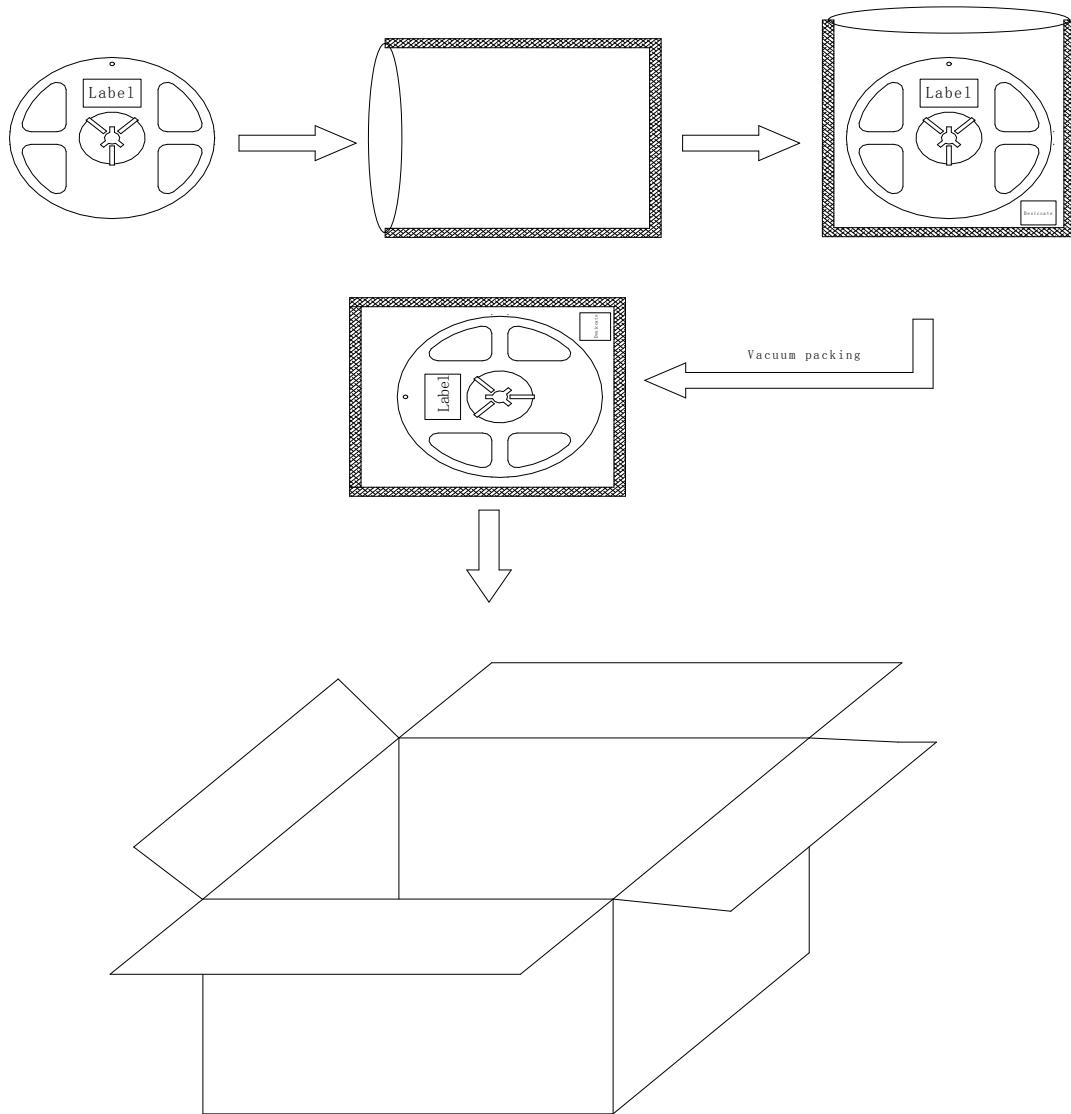
1. The tolerances unless mentioned  $\pm 0.1\text{mm}$ . Unit : mm
2. 1,000 pcs/Reel.

### ■ Label Form Specification



P/N	Part Number
QTY	Packing Quantity
LOT NO	Made Date
IV	Luminous intensity
CCT	Correlated Color Temperature
VF	Forward Voltage

### ■ Moisture Resistant Packing Process

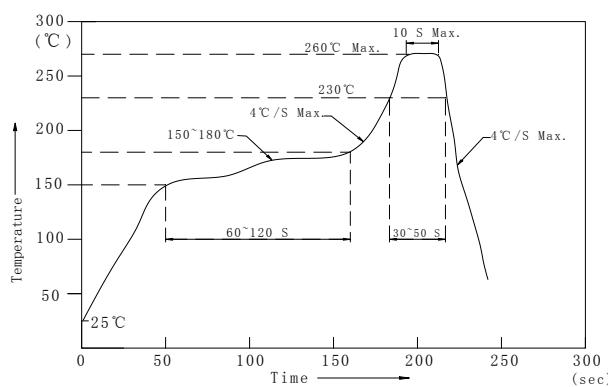


**Test items and results of reliability**

Type	Test Item	Test Conditions	Note	Number of Damaged
Environmental Sequence	Reflow	T <sub>a</sub> =260°C max T=10s	2 times	0/22
	Temperature Cycle	-40°C 30min ↑ 100°C 30min	100 cycle	0/22
	Thermal Shock	-40°C 15min ↑ 100°C 15min	100 cycle	0/22
	High Humidity Heat Cycle	30°C ⇄ 65°C 90%RH 24hrs/1cycle	10 cycle	0/22
	High Temperature Storage	T <sub>a</sub> =100°C	1000 hrs	0/22
	Low Temperature Storage	T <sub>a</sub> =-40°C	1000 hrs	0/22
	Humidity Heat Storage	T <sub>a</sub> =60°C RH=90%	1000 hrs	0/22
	Low Temperature Storage	T <sub>a</sub> =-30°C	1000 hrs	0/22
Operation Sequence	Life Test	T <sub>a</sub> =25°C IF=20mA	1000 hrs	0/22
	High Humidity Heat Life Test	60°C RH=90% IF=10mA	500 hrs	0/22
	Low Temperature Life Test	T <sub>a</sub> =-20°C IF=20mA	1000 hrs	0/22

## Reflow Profile

### ■ Reflow Temp/Time



### Notes:

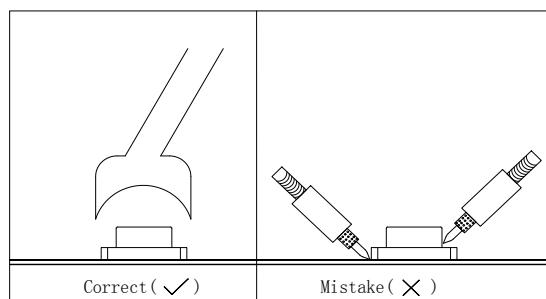
1. We recommend the reflow temperature 245°C ( $\pm 5^\circ\text{C}$ ). the maximum soldering temperature should be limited to 260°C.
2. Don't cause stress to the epoxy resin while it is exposed to high temperature.
3. Number of reflow process shall be 2 times or less.

### ■ Soldering iron

Basic spec is  $\leq 5$  sec when 260°C. If temperature is higher, time should be shorter ( $+10^\circ\text{C} \rightarrow -1$  sec ). Power dissipation of iron should be smaller than 20W, and temperatures should be controllable .Surface temperature of the device should be under 230°C .

### ■ Rework

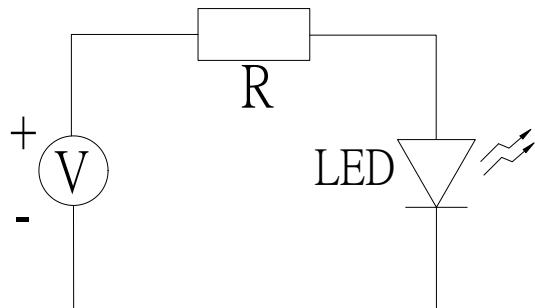
1. Customer must finish rework within 5 sec under 260°C.
2. The head of iron can not touch copper foil
3. Twin-head type is preferred.



- Avoid rubbing or scraping the resin by any object, during high temperature, for example reflow solder etc.

## Test circuit and handling precautions

### ■ Test circuit



### ■ Handling precautions

#### 1. Over-current-proof

Customer must apply resistors for protection; otherwise slight voltage shift will cause big current change (Burn out will happen).

#### 2. Storage

##### 2.1 It is recommended to store the products in the following conditions:

Humidity: 60% R.H. Max.

Temperature : 5°C~30°C(41°F~86°F)

##### 2.2 Shelf life in sealed bag: 12 month at <5°C~30°C and <30% R.H. After the package is

Opened, the products should be used within a week or they should be keeping to stored at  $\leq 20$  R.H. with zip-lock sealed.

#### 3. Baking

It is recommended to baking before soldering when the pack is unsealed after 72hrs. The Conditions are as

followings:

3.1  $70\pm3^\circ\text{C}$  x(12~24hrs) and <5%RH, taped reel type

3.2  $100\pm3^\circ\text{C}$  x(45min~1hr), bulk type

3.3  $130\pm3^\circ\text{C}$  x(15~30min), bulk type